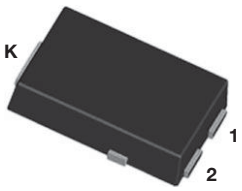
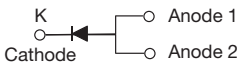
# High Current Density Surface Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F$ = 0.34 V at $I_F$ = 4 A

eSMP® Series




SMPC (TO-277A)




## FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

## ADDITIONAL RESOURCES

3D Models

## TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

**Case:** SMPC (TO-277A)
Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 suffix meets JESD 201 class 2 whisker test

| PRIMARY CHARACTERISTICS | |
|---|---|
| $I_{F(AV)}$ | 8.0 A |
| $V_{RRM}$ | 60 V |
| $I_{FSM}$ | 140 A |
| $V_F$ at $I_F$ = 8.0 A ($T_A$ = 125 °C) | 0.42 V |
| $T_J$ max. | 150 °C |
| Package | SMPC (TO-277A) |
| Circuit configuration | Single |

**MAXIMUM RATINGS** ($T_A$ = 25 °C unless otherwise noted)

| PARAMETER | SYMBOL | V8PL6-M3 | UNIT |
|---|---|---|---|
| Device marking code | | 8L6 | |
| Maximum repetitive peak reverse voltage | $V_{RRM}$ | 60 | V |
| Maximum average forward rectified current (fig. 1) | $I_F$ (1) | 8.0 | A |
| | $I_F$ (2) | 4.3 | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | $I_{FSM}$ | 140 | A |
| Voltage rate of change (rated $V_R$) | dV/dt | 10 000 | V/µs |
| Operating junction and storage temperature range | $T_J$, $T_{STG}$ | -40 to +150 | °C |

**Notes**
(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
(2) Free air, mounted on recommended copper pad area


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| ELECTRICAL CHARACTERISTICS ($T_A$ = 25 °C unless otherwise noted) | | | | | | |
|---|---|---|---|---|---|---|
| **PARAMETER** | **TEST CONDITIONS** | | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Instantaneous forward voltage | $I_F$ = 4.0 A | $T_A$ = 25 °C | $V_F$ (1) | 0.43 | - | V |
| | $I_F$ = 8.0 A | | | 0.50 | 0.58 | |
| | $I_F$ = 4.0 A | $T_A$ = 125 °C | | 0.34 | - | |
| | $I_F$ = 8.0 A | | | 0.42 | 0.52 | |
| Reverse current | $V_R$ = 60 V | $T_A$ = 25 °C | $I_R$ (2) | - | 2.4 | mA |
| | | $T_A$ = 125 °C | | 21 | 55 | |

**Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS ($T_A$ = 25 °C unless otherwise noted) | | | |
|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **V8PL6-M3** | **UNIT** |
| Typical thermal resistance | $R_{\theta JA}$ (1) (2) | 75 | °C/W |
| | $R_{\theta JM}$ (3) | 4 | |

**Notes**

(1) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction-to-ambient

(2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(3) Mounted on 30 mm x 30 mm Al PCB; thermal resistance $R_{\theta JM}$ - junction-to-mount

| ORDERING INFORMATION (Example) | | | | |
|---|---|---|---|---|
| **PREFERRED P/N** | **UNIT WEIGHT (g)** | **PREFERRED PACKAGE CODE** | **BASE QUANTITY** | **DELIVERY MODE** |
| V8PL6-M3/86A | 0.10 | 86A | 1500 | 7" diameter plastic tape and reel |
| V8PL6-M3/87A | 0.10 | 87A | 6500 | 13" diameter plastic tape and reel |

## RATINGS AND CHARACTERISTICS CURVES ($T_A$ = 25 °C unless otherwise noted)

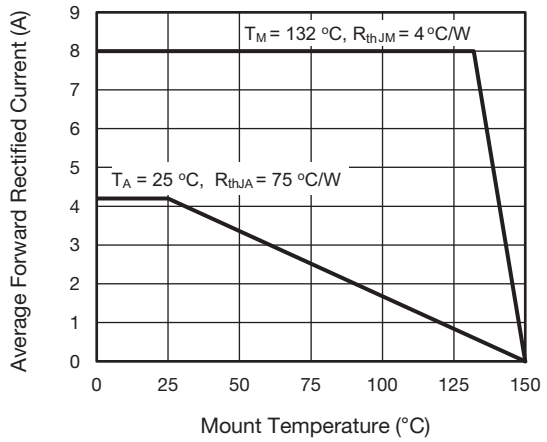



Fig. 1 - Maximum Forward Current Derating Curve

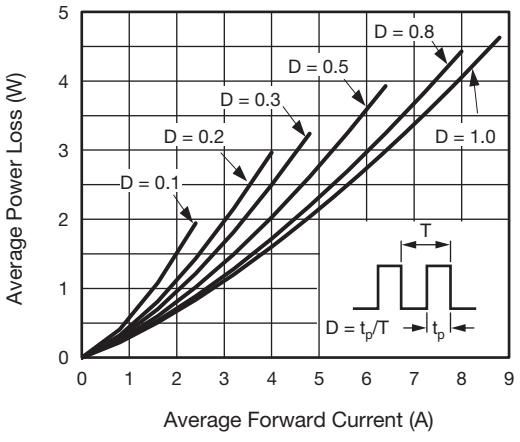



Fig. 2 - Forward Power Loss Characteristics



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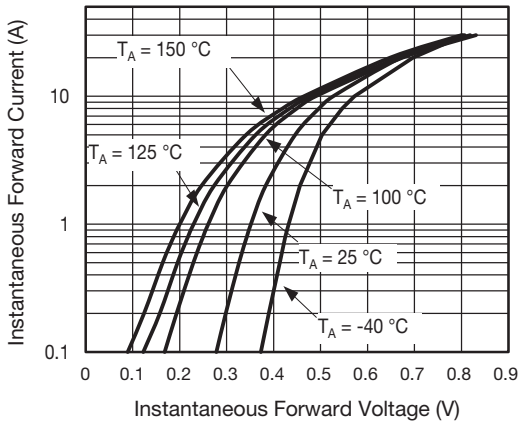



Fig. 3 - Typical Instantaneous Forward Characteristics

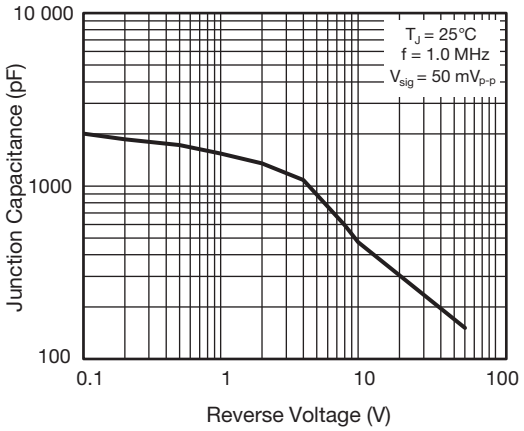



Fig. 5 - Typical Junction Capacitance

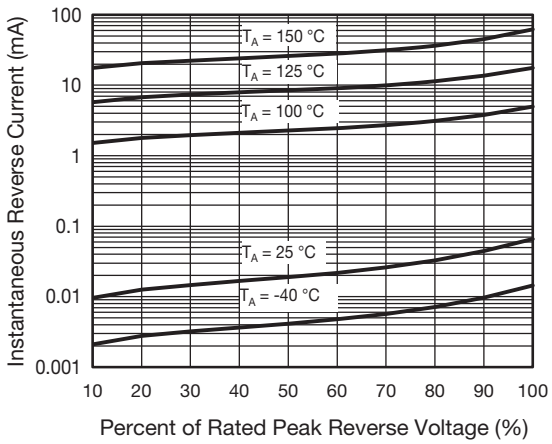



Fig. 4 - Typical Reverse Leakage Characteristics

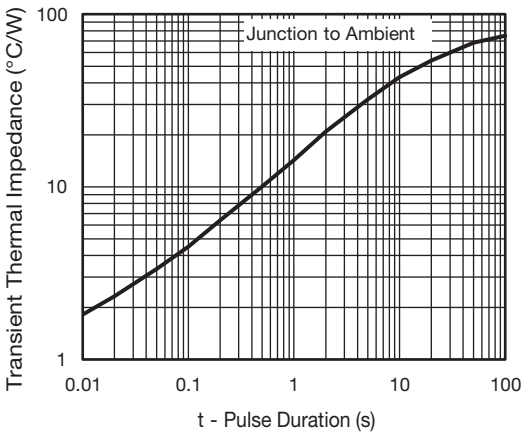
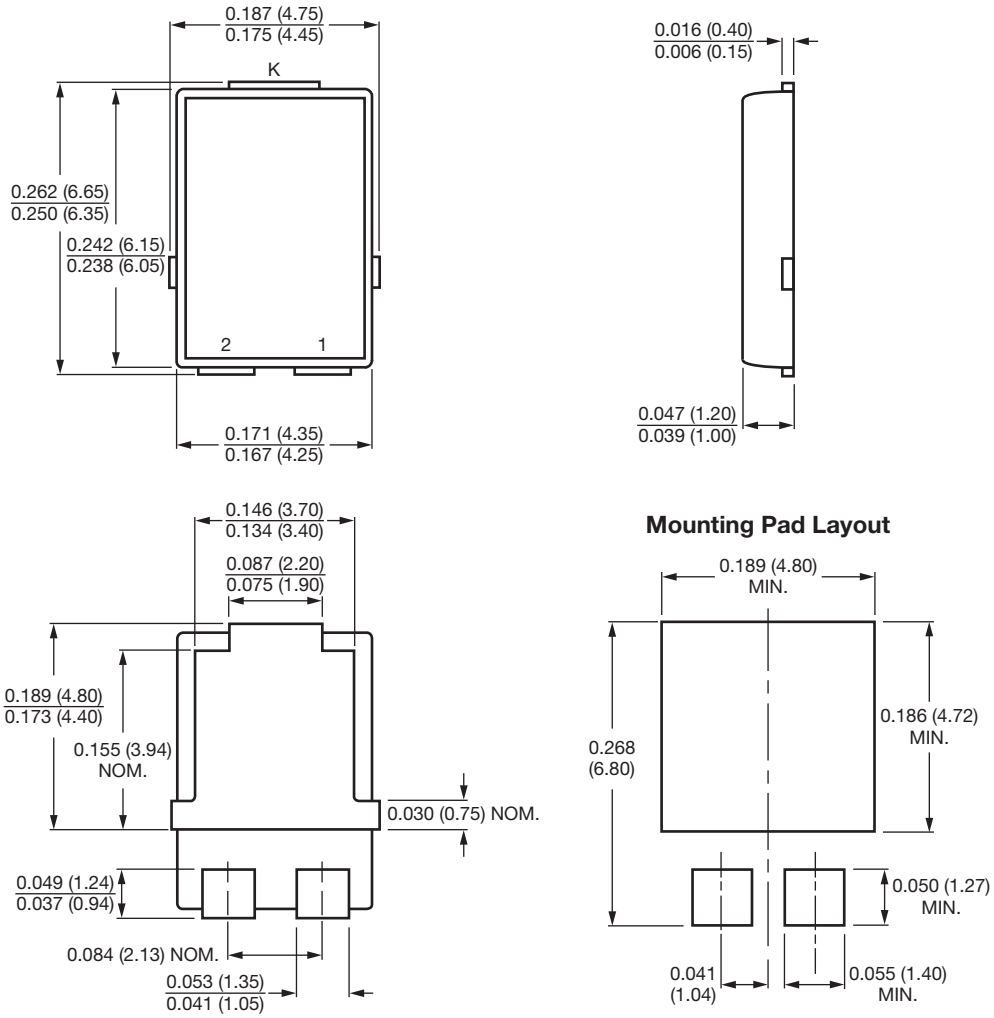



Fig. 6 - Typical Transient Thermal Impedance


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**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**SMPC (TO-277A)**




Conform to JEDEC® TO-277A


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